

1N5615US thru 1N5623US

SURFACE MOUNT VOIDLESS-HERMETICALLY SEALED FAST **RECOVERY GLASS RECTIFIERS**

DESCRIPTION

This "fast recovery" surface mount rectifier diode series is military qualified to MIL-PRF-19500/429 and is ideal for high-reliability applications where a failure cannot be tolerated. These industry-recognized 1.0 Amp rated rectifiers for working peak reverse voltages from 200 to 1000 volts are hermetically sealed with voidless-glass construction using an internal "Category I" metallurgical bond. These devices are also available in axial-leaded package configurations for thru-hole mounting (see separate data sheet for 1N5615 thru 1N5623). Microsemi also offers numerous other rectifier products to meet higher and lower current ratings with various recovery time speed requirements including fast and ultrafast device types in both through-hole and surface mount packages.

MICROSEMI's website: http://www.microsomi.co IMPO

APPEARANCE



PORTANT: For the most current data, consult <i>MICROSEMI's</i> website:	http://www.microsemi.com
FEATURES	APPLICATIONS / BENEFITS
 Surface mount package series equivalent to the JEDEC registered 1N5615 to 1N5623 series Voidless hermetically sealed glass package Triple-Layer Passivation Internal "<i>Category I</i>" Metallurgical bonds Working Peak Reverse Voltage 200 to 1000 Volts. JAN, JANTX, JANTXV, and JANS available per MIL-PRF-19500/429 Axial-leaded equivalents also available (see separate data sheet for 1N5615 thru 1N5623) 	 Fast recovery 1 Amp rectifiers 200 to 1000 V Military and other high-reliability applications General rectifier applications including bridges, half- bridges, catch diodes, etc. High forward surge current capability Extremely robust construction Low thermal resistance Controlled avalanche with peak reverse power capability Inherently radiation hard as described in Microsemi MicroNote 050
MAXIMUM RATINGS	MECHANICAL AND PACKAGING
 Junction & Storage Temperature: -65°C to +175°C Thermal Resistance: 13°C/W junction to end cap Thermal Impedance: 4.5°C/W @ 10 ms heating time Average Rectified Forward Current (I₀): 1.0 Amps @ T_A = 55°C Forward Surge Current: 30 Amps @ 8.3 ms half-sine Solder Temperatures: 260°C for 10 s (maximum) 	 CASE: Hermetically sealed voidless hard glass with Tungsten slugs TERMINATIONS: End caps are Copper with Tin/Lead (Sn/Pb) finish. Note: Previous inventory had solid Silver end caps with Tin/Lead (Sn/Pb) finish. MARKING & POLARITY: Cathode band only TAPE & REEL option: Standard per EIA-481-B WEIGHT: 193 mg See package dimensions and recommended pad

layout on last page

ELECTRICAL CHARACTERISTICS

TYPE	WORKING PEAK REVERSE VOLTAGE V _{RWM}	MINIMUM BREAKDOWN VOLTAGE V _{BR} @ 50µA	AVER RECT CURF I₀ @ (NOT	IFIED RENT TA TE 1)	FORWAR D VOLTAGE (MAX.) V _F @ 3A	CURI (MA	ERSE RENT AX.) V _{RWM}	CAPACITANCE (MAX.) C @ $V_R = 12 V$ f=1 MHz	MAXIMUM SURGE CURRENT I _{FSM} (NOTE 2)	REVERSE RECOVERY (MAX.) (NOTE 3) t _{rr}
	VOLTS	VOLTS	AM	PS	VOLTS	μ	A	pF	AMPS	ns
			50°C	100°C		25°C	100°C			
1N5615US	200	220	1.00	.750	.8 MIN.	.5	25	45	25	150
1N5617US	400	440	1.00	.750		.5	25	35	25	150
1N5619US	600	660	1.00	.750		.5	25	25	25	250
1N5621US	800	880	1.00	.750	1.6	.5	25	20	25	300
1N5623US	1000	1100	1.00	.750	MAX.	.5	25	15	25	500

NOTE 1: From 1 Amp at $T_A = 55^{\circ}$ C, derate linearly at 5.56 mA/ °C to 0.75 Amp at $T_A = 100^{\circ}$ C. From $T_A = 100^{\circ}$ C, derate linearly at 7.5 mA/ $^{\circ}$ C to 0 Amps at T_A = 200 $^{\circ}$ C. These ambient ratings are for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where T_{J(max)} does not exceed 175 °C. **NOTE 2:** $T_A = 100 \degree C$, f = 60 Hz, $I_Q = 750 \text{ mA}$ for ten 8.3 ms surges @ 1 minute intervals **NOTE 3:** $I_F = 0.5A$, $I_{RM} = 1A$, $I_{R(REC)} = 0.250 A$

Microsemi Scottsdale Division

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SYMBOLS & DEFINITIONS						
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V _{BR}	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current					
V _{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range					
Ι _Ο	Average Rectified Output Current: Output Current averaged over a full cycle with a 50 hZ or 60 Hz sine-wave input and a 180 degree conduction angle					
V _F	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current					
I _R	Maximum Leakage Current: The maximum leakage current that will flow at the specified voltage and temperature					
С	Capacitance: The capacitance in pF at a frequency of 1 MHz and specified voltage					
t _{rr}	Reverse Recovery Time: The time interval between the instant the current passes through zero when changing from the forward direction to the reverse direction and a specified decay point after a peak reverse current occurs.					

GRAPHS

10K

5K

2K

1K

500

200

100

50

20

10

5

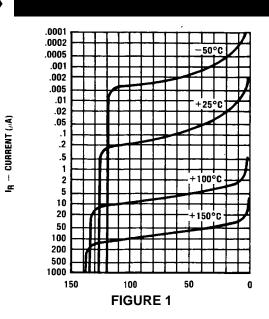
2

1

.2 .4 .6

IF — CURRENT (mA)





TYPICAL REVERSE CURRENT vs V_R

TYPICAL FORWARD VOLTAGE vs FORWARD CURRENT

FIGURE 2

.8 1

V_F — VOLTAGE (V)

50°C

1.4 1.2

1.6

25 C

+ 175

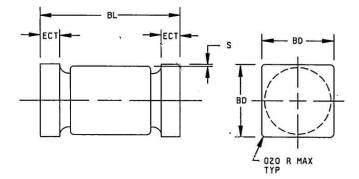
+100°C

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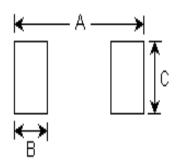
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PACKAGE DIMENSIONS AND PAD LAYOUT



NOTE: This Package Outline has also previously been identified as "D-5A"

	INC	HES	mm		
	MIN	MAX	MIN	MAX	
BD	.097	.103	2.46	2.62	
BL	.185	.200	4.70	5.08	
ECT	.019	.028	0.48	0.71	
S	.003		0.08		



PAD LAYOUT

	INCHES	mm			
Α	0.246	6.25			
В	0.067	1.70			
С	0.105	2.67			
Note: If mounting requires adhesive separate from the solder, an additional 0.060 inch diameter contact may be placed in the center between the pads as an optional spot for cement.					

Mouser Electronics

Authorized Distributor

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Microchip:

<u>JANTX1N5615US</u> <u>JANTXV1N5617US</u> <u>JANTX1N5617US</u> <u>JAN1N5615US</u> <u>1n5615us</u> <u>1N5623US</u> <u>1N5621US</u> 1N5619US 1N5617US